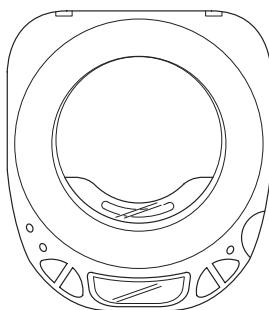




XP-V311

ALH1(S) ALHB(S)
ALH(LL)



SERVICE MANUAL

COMPACT DISC PLAYER

BASIC CD MECHANISM : DA23L

This Service Manual is the "Revision Publishing" and replaces "Simple Manual" (S/M Code No. 09-003-339-8T1).

aiwa
S/M Code No. 09-003-339-8R1

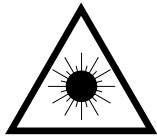
REVISION
DATA

PROTECTION OF EYES FROM LASER BEAM DURING SERVICING

This set employs laser. Therefore, be sure to follow carefully the instructions below when servicing.

WARNING!

WHEN SERVICING, DO NOT APPROACH THE LASER EXIT WITH THE EYE TOO CLOSELY. IN CASE IT IS NECESSARY TO CONFIRM LASER BEAM EMISSION. BE SURE TO OBSERVE FROM A DISTANCE OF MORE THAN 30cm FROM THE SURFACE OF THE OBJECTIVE LENS ON THE OPTICAL PICK-UP BLOCK.



- Caution: Invisible laser radiation when open and interlocks defeated avoid exposure to beam.
- Advarsel: Usynlig laserstråling ved åbning, når sikkerhedsafbrydere er ude af funktion. Undgå udsættelse for stråling.

VAROITUS!

Laiteen Käyttäminen muulla kuin tässä käyttöohjeessa mainitulla tavalla saattaa altistaa käyt-täjän turvallisuusluokan 1 ylit-täälle näkymättömälle lasersäteilylle.

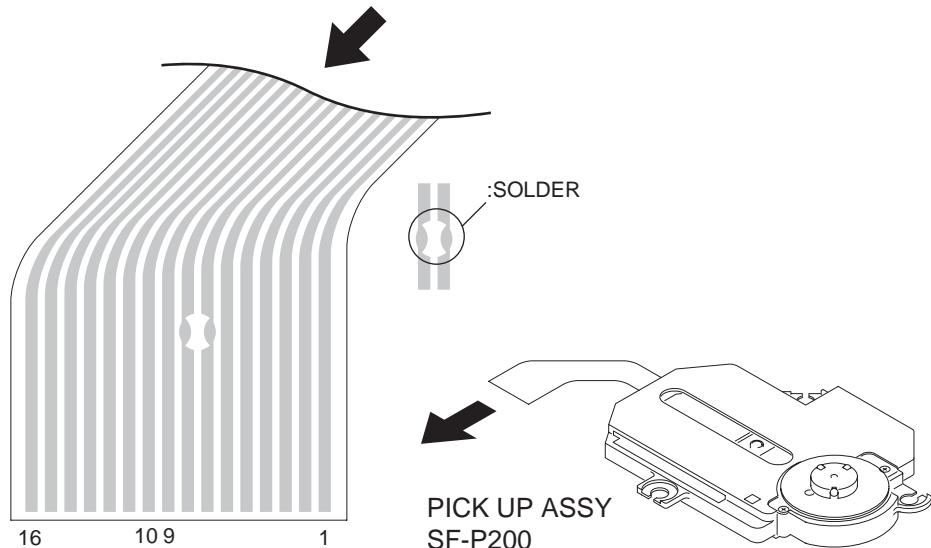
VARNING!

Om apparaten används på annat sätt än vad som specificeras i denna bruksanvisning, kan användaren utsättas för osynlig laserstrålning, som överskrider gränsen för laserklass 1.

Precaution to replace Optical block (SF-P200)

Body or clothes electrostatic potential could ruin laser diode in the optical block. Be sure ground body and workbench, and use care the clothes do not touch the diode.

- 1) After the connection, remove solder shown in the right figure.



CAUTION

Use of controls or adjustments or performance of procedures other than those specified herein may result in hazardous radiation exposure.

ATTENTION

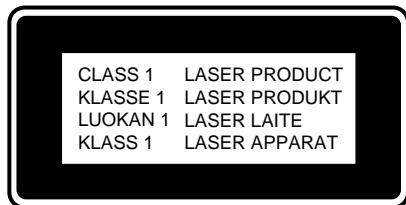
L'utilisation de commandes, réglages ou procédures autres que ceux spécifiés peut entraîner une dangereuse exposition aux radiations.

ADVARSEL!

Usynlig laserstråling ved åbning, når sikkerhedsafbrydere er ude af funktion. Undgå udsættelse for stråling.

This Compact Disc player is classified as a CLASS 1 LASER product.

The CLASS 1 LASER PRODUCT label is located on the rear exterior.



SPECIFICATIONS

Tracking system	3-beam laser
Laser pickup	Semiconductor laser
D/A conversion	8-times oversampling digital filter + 1-bit DAC
Frequency response	20 – 20,000 Hz
Output	PHONES/LINE OUT jack (stereo mini-jack)
Maximum output	12 mW + 12 mW (EIAJ 16 ohms at 1 kHz) 500 mV (47 k ohms at 1 kHz)
Power supply	DC 3 V using two LR6 (size AA) alkaline batteries DC 2.4 V using two commercially available rechargeable batteries (Ni-Cd 1.2 V 700 mAh) AC house current using the supplied AC adaptor
Maximum outside dimensions	128 (W) × 28 (H) × 144.5 (D) mm (5 1/8 × 1 1/8 × 5 3/4 in.) (excluding projecting parts and controls)
Weight	Approx. 220g (7.7 oz.) excluding batteries
Accessories	AC adaptor AC-D603 (1) Stereo headphones (1)
«AC Adaptor»	
Rated input	For the customer in Argentina AC-D603 HA: 230 V AC, 50 Hz For the customer except in Argentina AC-D603 HR: 115/230 V AC, switchable, 50/60 Hz

- Design and specifications are subject to change without notice.

ELECTRICAL MAIN PARTS LIST

DESCRIPTIONで判断できない物は "REFERENCE NAME LIST" を参照してください。
If can't understand for Description please kindly refer to "REFERENCE NAME LIST".

REF. NO	PART NO.	KANRI NO.	DESCRIPTION	REF. NO	PART NO.	KANRI NO.	DESCRIPTION
IC				C354	87-010-196-080		CHIP CAPACITOR, 0.1-25
87-A21-448-040	C-IC,BH6554FV			C355	87-010-312-080	C-CAP,S 15P-50 CH	
87-A21-083-040	C-IC,BH6508FS			C356	87-010-312-080	C-CAP,S 15P-50 CH	
87-A21-381-040	C-IC,LA9235M			C357	87-010-196-080	CHIP CAPACITOR, 0.1-25	
87-A21-591-010	C-IC,LC78641NE-D			C358	87-010-322-080	C-CAP,S 100P-50 CH	
87-A21-085-040	C-IC,TA2120FN			C359	87-A10-369-080	C-CAP,S 0.47-16 K B	
8A-HC7-601-010	C-IC,UPD789405AGC-013			C360	87-016-669-080	C-CAP,S 0.1-25 K B	
				C361	87-010-322-080	C-CAP,S 100P-50 CH	
				C362	87-016-669-080	C-CAP,S 0.1-25 K B	
				C363	87-010-197-080	CAP, CHIP 0.01 DM	
TRANSISTOR				C364	87-016-369-080	C-CAP,S 0.033-25	
89-211-323-080	C-TR,2SB1132R			C365	87-010-322-080	C-CAP,S 100P-50 CH	
87-A30-332-040	C-TR,CPH3106			C366	87-010-196-080	CHIP CAPACITOR, 0.1-25	
87-A30-278-040	C-FET,2SK2980			C367	87-010-175-080	CAP 560P	
87-A30-287-040	C-TR,DTC114TKA			C368	87-010-196-080	CHIP CAPACITOR, 0.1-25	
87-A30-246-040	C-TR,2SA1037AK			C701	87-010-501-040	E/CAP GAS 47-4	
86-NFZ-667-040	C-TR,DTC123JKA			C702	87-010-495-040	CAP,E 2.2-50 GAS	
89-416-643-080	C-TR,2SD1664R			C703	87-010-498-040	CAP,E 10-16 GAS	
89-324-123-080	C-TR,2SC2412KS			C704	87-010-503-040	CAP,E 220-4 GAS	
				C705	87-010-503-040	CAP,E 220-4 GAS	
DIODE				C706	87-010-498-040	CAP,E 10-16 GAS	
87-A40-592-040	C-ZENER,HZM11NB2			C707	87-010-501-040	E/CAP GAS 47-4	
87-A40-590-040	C-DIODE,HRW0202A			C708	87-A10-826-080	C-CAP,S 1-10 K B	
87-A40-554-040	C-DIODE,RB491D			C709	87-A10-826-080	C-CAP,S 1-10 K B	
87-A40-469-080	C-DIODE,HSM2838CTR			C710	87-010-175-080	CAP 560P	
87-A40-836-040	C-ZENER,HZM6.2NB1			C711	87-010-175-080	CAP 560P	
MAIN C.B				C712	87-012-141-080	CHIP-CAPACITOR, 0.22-16F	
C101	87-010-553-040	CAP,E 47-16 GAS		C713	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C102	87-010-551-040	CAP,E 33-10 GAS		C714	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C103	87-A10-505-040	CAP,E 220-6.3 105 SF		C715	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C104	87-010-503-040	CAP,E 220-4 GAS		C716	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C105	87-010-498-040	CAP,E 10-16 GAS		C717	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C106	87-010-502-040	CAP ELECT GAS 100/4		C718	87-010-178-080	CHIP CAP 1000P	
C107	87-010-196-080	CHIP CAPACITOR, 0.1-25		C719	87-010-178-080	CHIP CAP 1000P	
C108	87-012-145-080	CAP, CHIP S 270P CH		C801	87-010-501-040	E/CAP GAS 47-4	
C109	87-010-198-080	CAP, CHIP 0.022		C802	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C110	87-A10-826-080	C-CAP,S 1-10 K B		C803	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C111	87-010-196-080	CHIP CAPACITOR, 0.1-25		C804	87-010-178-080	CHIP CAP 1000P	
C112	87-010-196-080	CHIP CAPACITOR, 0.1-25		C805	87-010-322-080	C-CAP,S 100P-50 CH	
C113	87-A10-826-080	C-CAP,S 1-10 K B		C806	87-010-319-080	C-CAP,S 56P-50 CH	
C115	87-010-196-080	CHIP CAPACITOR, 0.1-25		C807	87-010-319-080	C-CAP,S 56P-50 CH	
C116	87-010-196-080	CHIP CAPACITOR, 0.1-25		C808	87-010-196-080	CHIP CAPACITOR, 0.1-25	
C117	87-010-196-080	CHIP CAPACITOR, 0.1-25		CN201	87-A61-104-010	CONN,16P H WHITE 52089-1610	
C201	87-A10-505-040	CAP,E 220-6.3 105 SF		CN202	87-009-411-010	CONN,6P ZH V	
C202	87-010-175-080	CAP 560P		J101	87-A60-421-010	JACK,DC HEC3600 BLK 6	
C204	87-010-213-080	C-CAP,S 0.015-50 B		J701	85-HC5-616-010	JACK,3.5 ST W/R GRN	
C205	87-010-213-080	C-CAP,S 0.015-50 B		L101	87-A50-574-010	COIL,100UH #7607	
C206	87-A10-826-080	C-CAP,S 1-10 K B		L102	87-A50-573-010	COIL,330UH LHL06NB	
C207	87-A10-826-080	C-CAP,S 1-10 K B		L301	87-A50-455-080	C-COIL,47UH-FSLB2520	
C208	87-010-177-080	C-CAP,S 820P-50 SL		L302	87-A50-501-080	C-COIL,10UH-FSLB2520	
C209	87-010-213-080	C-CAP,S 0.015-50 B		L351	87-A50-501-080	C-COIL,10UH-FSLB2520	
C210	87-010-213-080	C-CAP,S 0.015-50 B		L801	87-A50-501-080	C-COIL,10UH-FSLB2520	
C212	87-A10-826-080	C-CAP,S 1-10 K B		L802	87-A50-455-080	C-COIL,47UH-FSLB2520	
C301	87-016-557-040	CAP,E 100-6.3 SF		LCD101	8A-HC7-602-010	LCD,AHC-7	
C302	87-010-502-040	CAP ELECT GAS 100/4		R105	87-022-355-080	C-RES,S10K-1/10W F	
C303	87-016-557-040	CAP,E 100-6.3 SF		R107	87-022-358-080	C-RES,S 18K-1/10W F	
C304	87-010-502-040	CAP ELECT GAS 100/4		R307	87-022-202-080	C-RES,S33K 1/10WF	
C305	87-010-501-040	E/CAP GAS 47-4		R308	87-022-202-080	C-RES,S33K 1/10WF	
C306	87-010-196-080	CHIP CAPACITOR, 0.1-25		R309	87-022-202-080	C-RES,S33K 1/10WF	
C308	87-010-196-080	CHIP CAPACITOR, 0.1-25		R310	87-022-202-080	C-RES,S33K 1/10WF	
C309	87-010-178-080	CHIP CAP 1000P		R311	87-022-364-080	C-RES,S 82K-1/10W F	
C311	87-010-318-080	C-CAP,S 47P-50 CH		R312	87-022-364-080	C-RES,S 82K-1/10W F	
C313	87-A10-826-080	C-CAP,S 1-10 K B		S101	87-A90-095-080	SW,TACT EVQ11G04M	
C314	87-A10-201-080	C-CAP,S0.33-16 KB		S102	87-A90-095-080	SW,TACT EVQ11G04M	
C351	87-016-557-040	CAP,E 100-6.3 SF		S103	87-A90-095-080	SW,TACT EVQ11G04M	
C352	87-010-503-040	CAP,E 220-4 GAS		S104	87-A90-095-080	SW,TACT EVQ11G04M	
C353	87-A10-826-080	C-CAP,S 1-10 K B		S105	87-A90-095-080	SW,TACT EVQ11G04M	
				S106	87-A90-095-080	SW,TACT EVQ11G04M	
				S801	87-A91-622-010	SW,MICRO PV1102	
				S802	87-A91-742-010	SW,SL 4-1-3 HSW2061-010010	

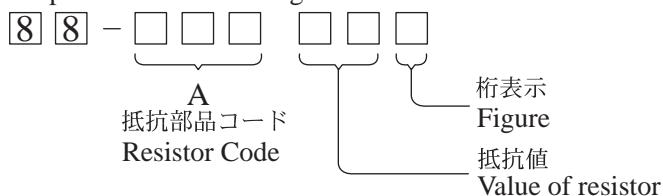
REF. NO	PART NO.	KANRI NO.	DESCRIPTION
VR701	87-A90-462-010	VR,RTRY	30KCX2 H RK14J12A0
X351	87-A70-202-080	C-VIB,CER	16.93MHZ CSACV-MXJ04

- Regarding connectors, they are not stocked as they are not the initial order items. The connectors are available after they are supplied from connector manufacturers upon the order is received.

○チップ抵抗部品コード／CHIP RESISTOR PART CODE

チップ抵抗部品コードの成り立ち

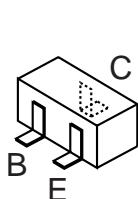
Chip Resistor Part Coding



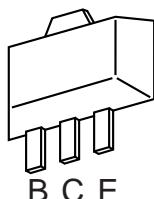
チップ抵抗 Chip resistor

容量 Wattage	種類 Type	許容誤差 Tolerance	記号 Symbol	寸法/Dimensions (mm)			抵抗コード : A Resistor Code : A	
				外形/Form	L	W		
1/16W	1005	± 5%	CJ		1.0	0.5	0.35	104
1/16W	1608	± 5%	CJ		1.6	0.8	0.45	108
1/10W	2125	± 5%	CJ		2	1.25	0.45	118
1/8W	3216	± 5%	CJ		3.2	1.6	0.55	128

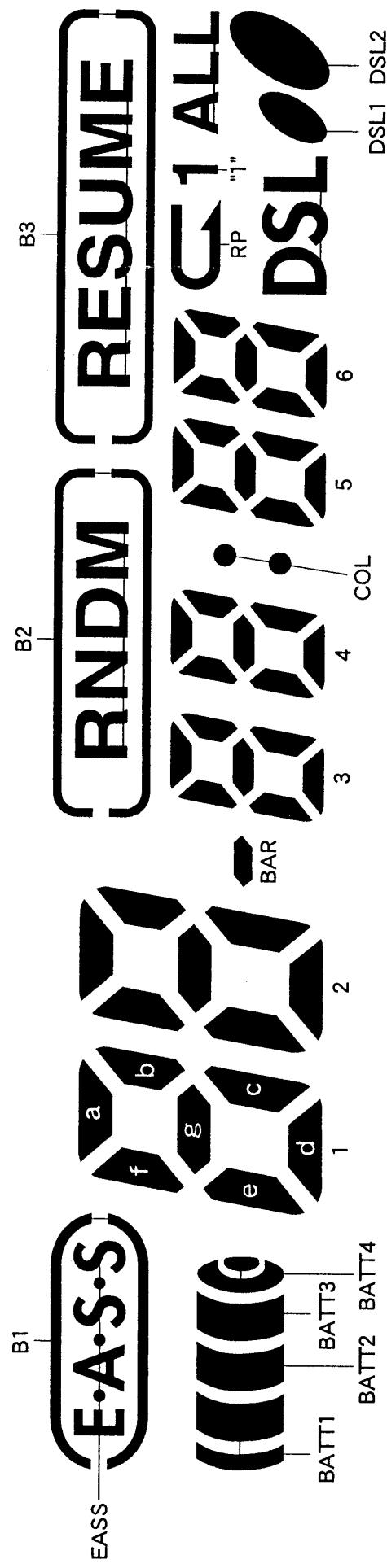
TRANSISTOR ILLUSTRATION



2SA1037
2SC2412
2SK2980
CPH3106
DTC114TK
DTC123.IK

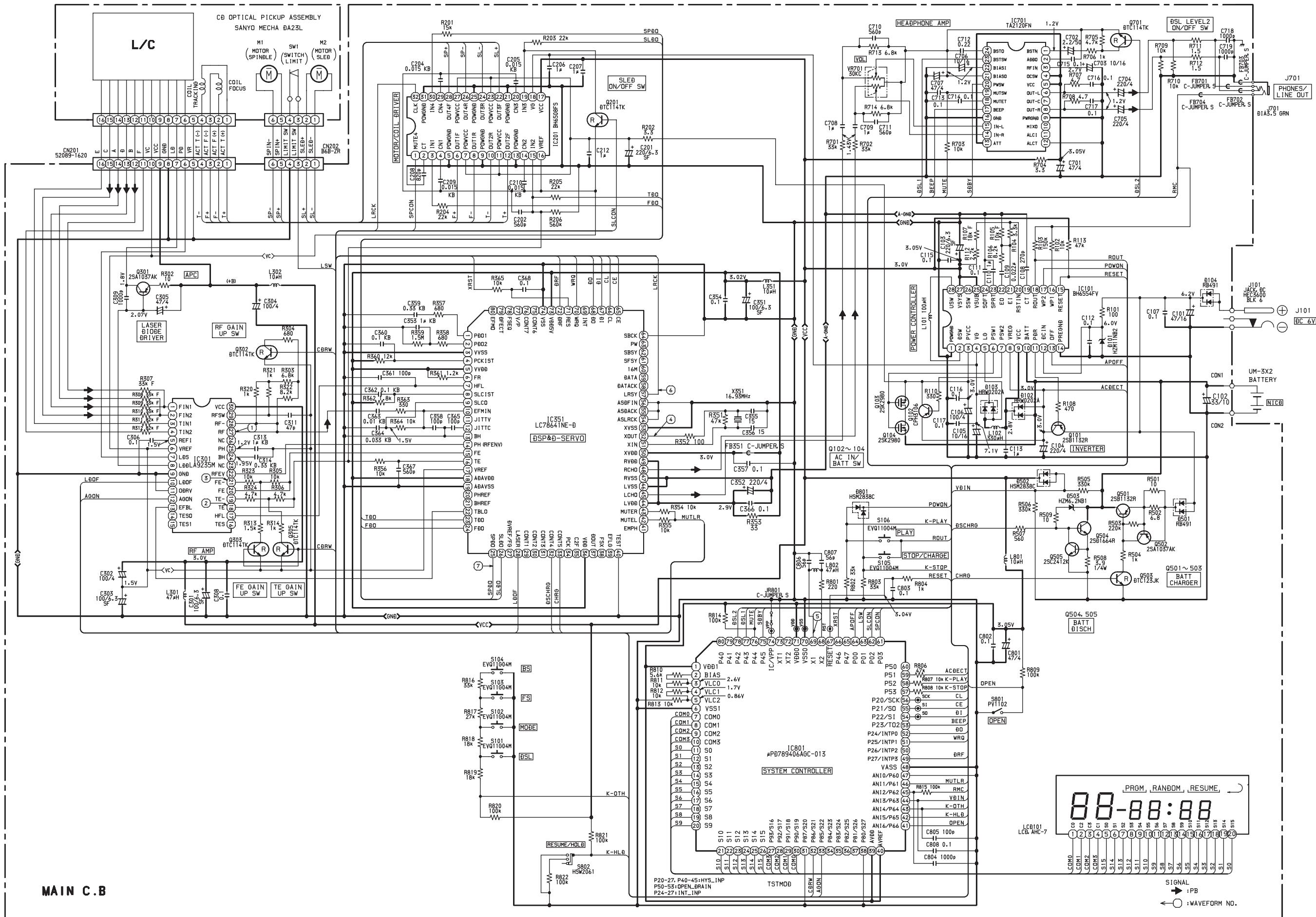


2SB1132
2SD1664

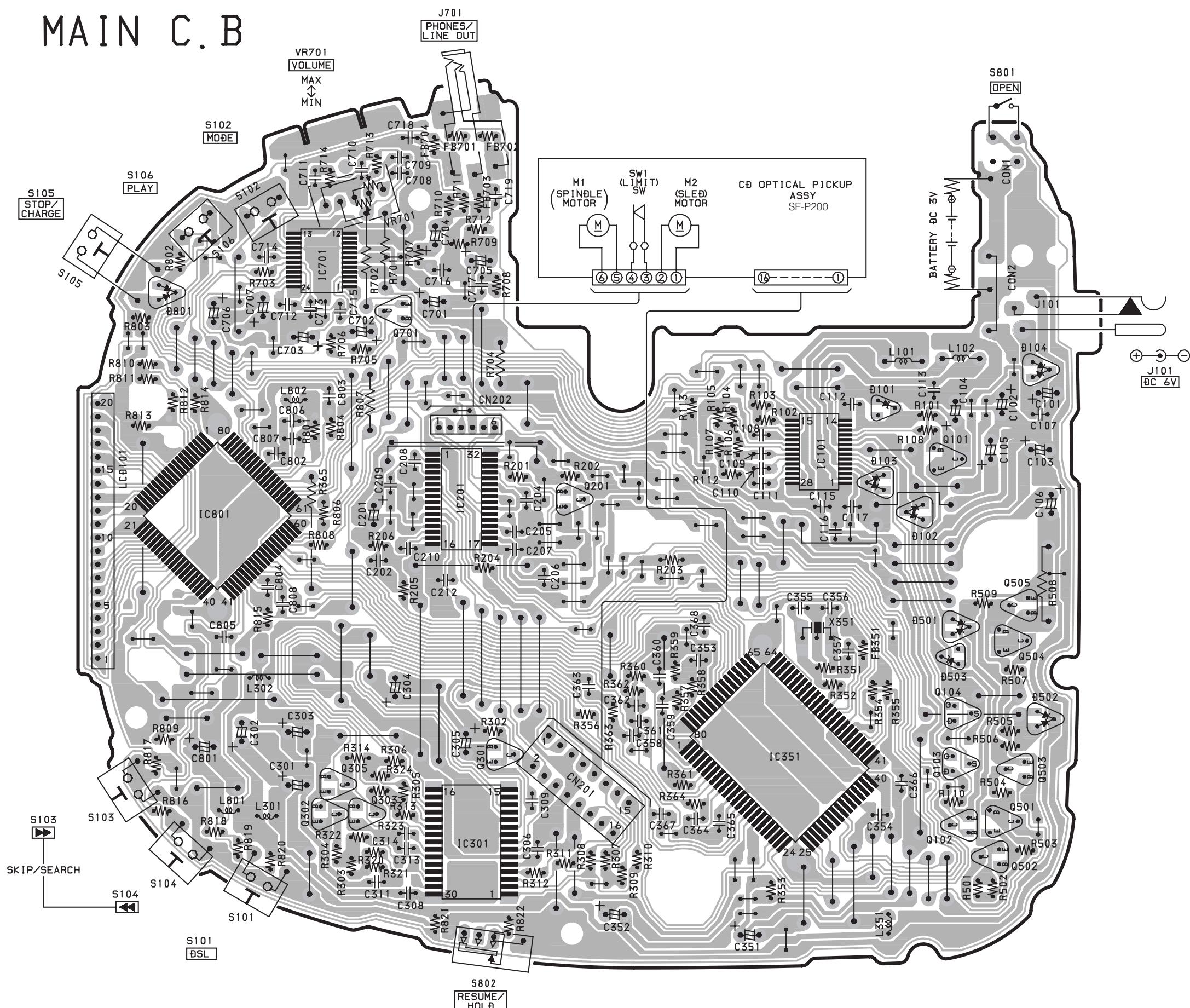


No	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
COM0	COM0	—	—	—	—	BATT2	B1	RNDM	1a	—	2a	BAR	3a	—	4a	COL	5a	B2	6a	B3
COM1	—	—	—	—	—	COM1	BATT1	EASS	1f	1b	2f	2b	3f	3b	4f	4b	5f	5b	6f	6b
COM2	—	—	—	—	—	BATT3	—	—	1e	1g	2e	2g	3e	3g	4e	4g	5e	5g	6e	6g
COM3	—	—	—	—	—	COM3	—	—	1d	1c	2d	2c	3d	3c	4d	4c	5d	5c	6d	6c
																	DSL	DSL1	DSL2	

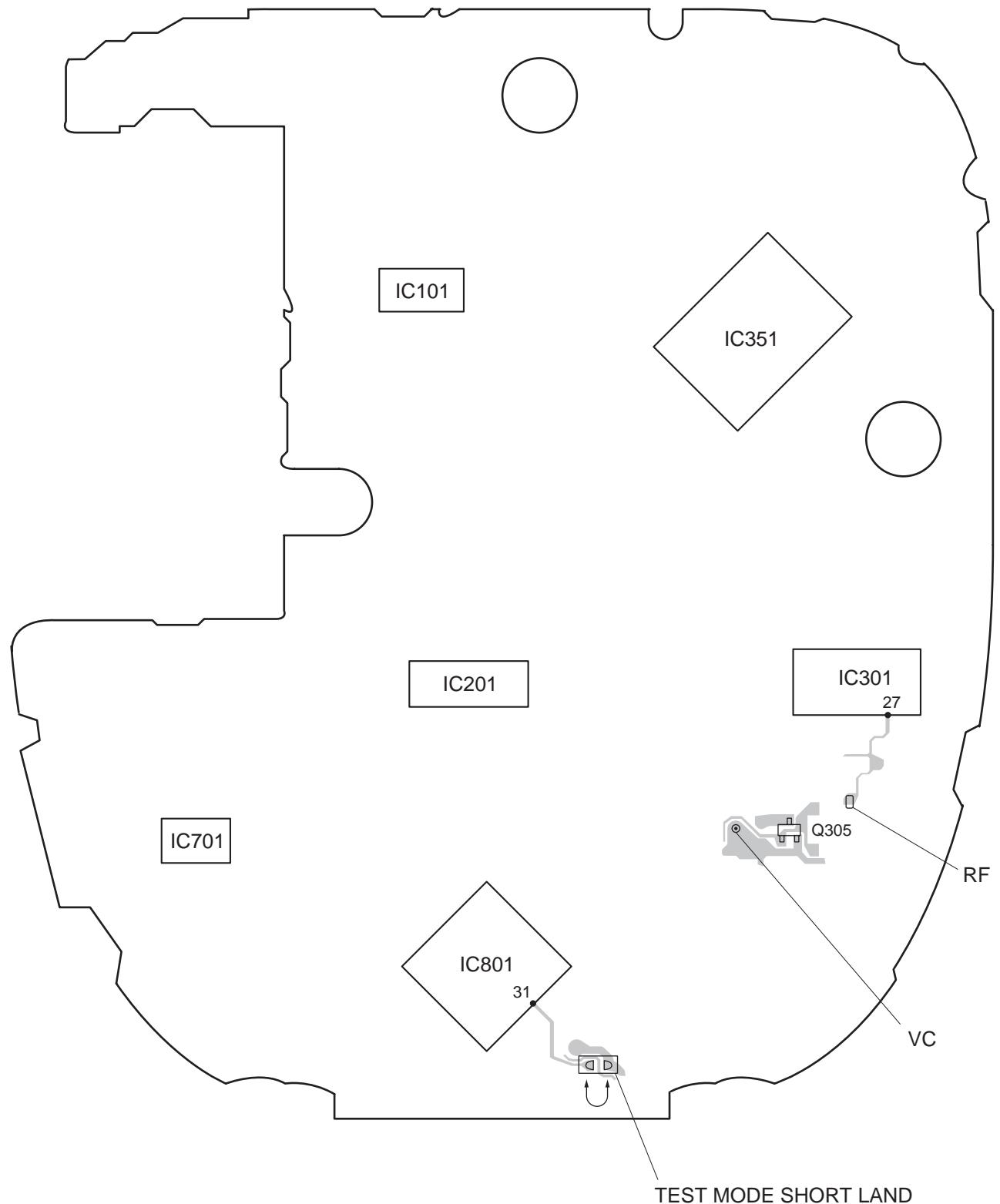
SCHEMATIC DIAGRAM



MAIN C. E.



TEST MODE



The servo circuit of this model has been designed to be free of adjustments and controlled within the IC. Therefore, adjustments and disk judgement are performed automatically every time the TOC is read out. The adjustment status of each servo inside the IC can be monitored in this test mode.

1. Startup procedure

- 1) Short the test land.
- 2) Insert the AC plug.
- 3) Press the STOP button. (The test mode starts.)

Note 1) The test mode is canceled by disconnecting the AC plug.

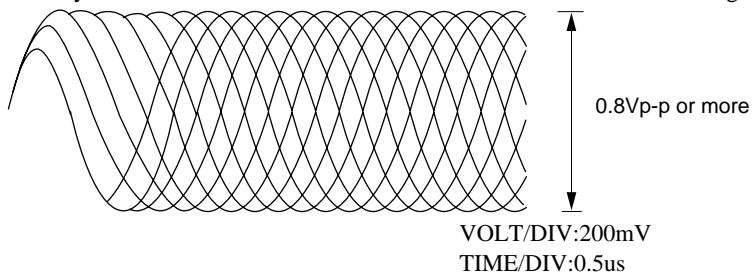
Note 2) The OPEN/CLOSE switch cannot be operated during the test mode.

2. Checking the RF level

Test point: RF & VC (Vref)

Test disk: TCD-782

Play back the disk and confirm that the RF waveform is in the following state:



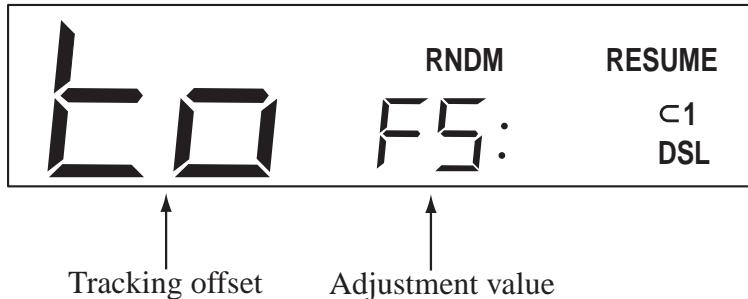
3. Checking each servo

The adjustment values of each servo can be checked by pressing the MODE button repeatedly during playback. The switching procedure is as follows.

Check mode OFF → Vref offset (RO) → focus offset (FO) → tracking offset (TO) → tracking balance (TB) → tracking gain (TG) → focus gain (FG) → focus bias (FB) → check mode OFF

Example: Tracking offset (TO)

Adjustment value → F5



* Adjustment values are indicated in hexadecimal.

When displaying each mode on the LCD and pressing the PLAY button in the STOP status, the center value is displayed on the LCD.

After the disk starts rotating, the adjustment value that was set during automatic adjustment is displayed. The display range of the center values and adjustment values of each mode are as follows. There are 256 steps for displaying the values of all modes.

Center value	Center value	Display range
1) Vref offset (RO)	00	80-7F
2) Focus offset (FO)	00	80-7F
3) Tracking offset (TO)	00	80-7F
4) Tracking balance (TB)	80	00-FF
5) Tracking gain (TG)	40	00-FF
6) Focus gain (FG)	40	00-FF
7) Focus bias (FB)	00	80-7F

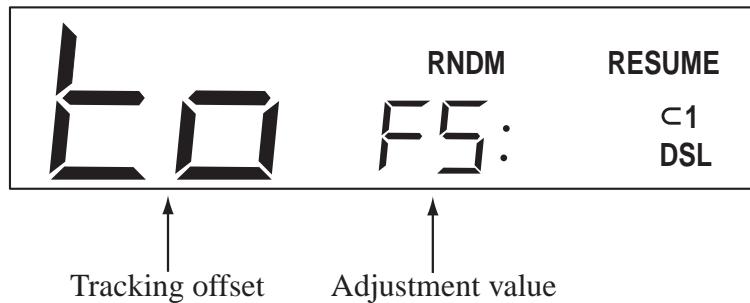
4. Amount of change of jitter

The amount of change of jitter is displayed in the focus bias check mode. The displayed value has 256 steps from 00 to FF.

Example: focus bias (FB)

Adjustment value→00

Jitter value→FD

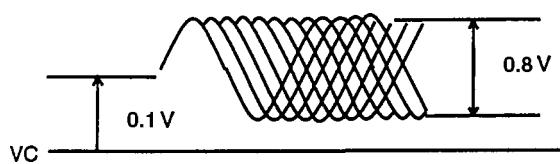


* Adjustment values and jitter values are indicated in hexadecimal.

WAVE FORM

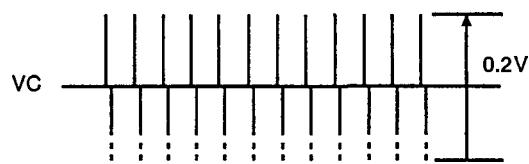
① IC301 Pin ②7
RF

VOLT/DIV: 0.2V
TIME/DIV: 0.5μS



⑦ IC601 Pin ②5
SPDO

VOLT/DIV: 0.1V
TIME/DIV: 5mS



② IC301 Pin ⑯
TE

VOLT/DIV: 0.2V
TIME/DIV: 50μS



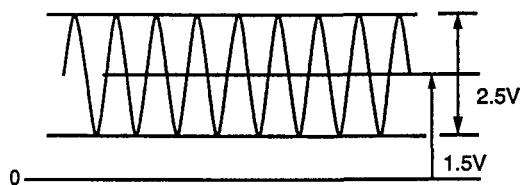
③ IC301 Pin ⑯
FE-

VOLT/DIV: 0.1V
TIME/DIV: 2mS



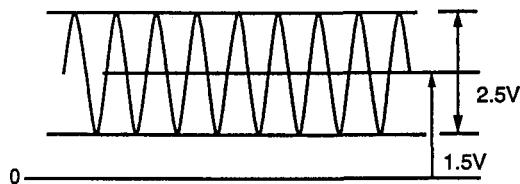
④ IC351 Pin ⑯2
XOUT

VOLT/DIV: 1V
TIME/DIV: 50nS
f=16.93MHz



⑤ IC801 Pin ⑯9
X1

VOLT/DIV: 1V
TIME/DIV: 0.2μS
f=4.2MHz



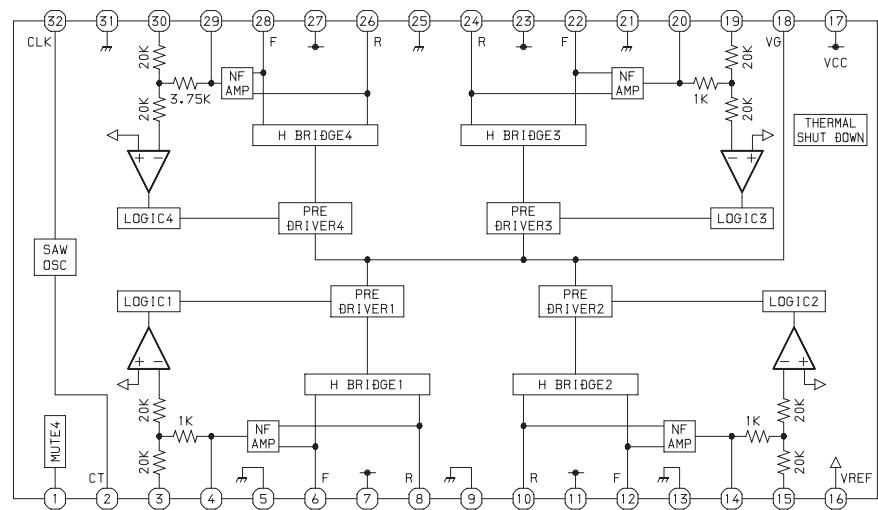
⑥ IC351 Pin ⑯7
LRSY

VOLT/DIV: 2V
TIME/DIV: 5μS
f=44.1kHz

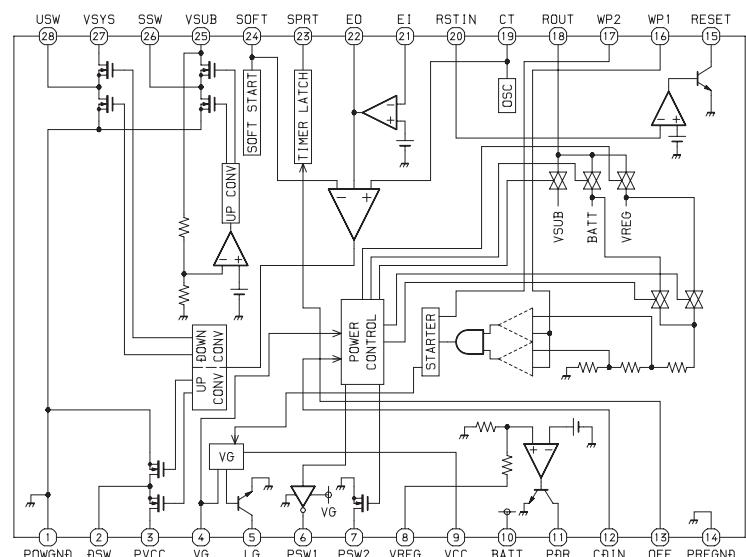


IC BLOCK DIAGRAM

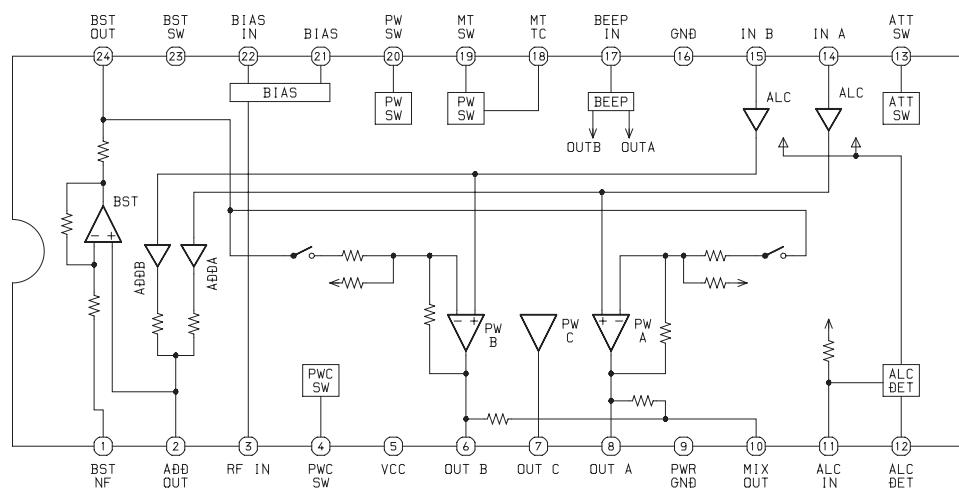
IC, BH6508FS



IC, BH6554FV



IC, TA2120FN



IC DESCRIPTION

IC, LC78641NE-D

Pin No.	Pin Name	I/O	Description
1	PDO1	O	Internal VCD control phase comparator output pin.
2	PDO2	O	Internal VCD control phase comparator output pin. OFF for rough servo, ON for phase servo.
3	VVSS	—	Internal VCD ground pin.
4	PCKIST	I	PDO output current adjustment resistor connection pin. (pull up)
5	VVDD	—	Internal VCD power supply pin. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)
6	FR	I	VCD frequency range adjustment resistor connection pin. (pull up)
7	HFL	I	Mirror detection signal input pin.
8	SLCIST	I	SLCO output current adjustment resistor connection pin. (pull up)
9	SLCO	O	Control output.
10	EFMIN	I	EFM signal input pin.
11	JITTV	O	Jitter detection monitor pin.
12	JITTC	O	Jitter detection adjustment pin.
13	BH	I	BH signal input pin. A/D input. (Must be connected to OV when unused)
14	PH (RFENV)	I	PH signal or RFENV signal input pin. A/D input.
15	FE	I	FE signal input pin. A/D input.
16	TE	I	TE signal input pin. A/D input.
17	VREF	I	VREF input pin. A/D input.
18	ADAVDD	—	Servo A/D, D/A power supply pin. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)
19	ADAVSS	—	Servo A/D, D/A ground pin.
20	PHREF	O	PH reference output pin. D/A output.
21	BHREF	O	BH reference output pin. D/A output.
22	TBLO	O	Tracking balance output pin. D/A output.
23	TDO	O	Tracking control output pin. D/A output.
24	FDO	O	Focus control output pin. D/A output.
25	SPDO	O	Spindle control output pin. D/A output.
26	SLDO	O	Thread control output pin. D/A output.
27	DVREF/FG	I/O	Output driver VREF output pin. Input FG signal input pin. (Must be connected to OV when unused)
28	LASER	O	Laser ON/OFF control pin.
29	CONT1	I/O	General-purpose input/output pin 1.
30	CONT2	I/O	General-purpose input/output pin 2.
31	CONT3	I/O	General-purpose input/output pin 3.
32	CONT4	I/O	General-purpose input/output pin 4.
33	CONT5	I/O	General-purpose input/output pin 5.
34	PCK	O	EFM data playback clock monitor pin. Average 4.3218MHz when the phase is locked.
35	C2F	O	C2 flag output pin.
36	VDD	—	Digital power supply pin. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)

Pin No.	Pin Name	I/O	Description
37	DOUT	O	Digital OUT output pin. (EIAJ format)
38	FSX	O	Output pin for the 7.35kHz synchronization signal divided from the crystal oscillator.
39	EFLG	O	
40	TEST	I	C1 C2 error correction monitor pin. Test input pin. Must be connected to OV.
41	EMPH	I/O	Emphasis pin. Which becomes an input pin after reset and can be controlled externally. This becomes an emphasis monitor pin under control by command.
42	MUTEL	O	L channel mute output pin.
43	MUTER	O	R channel mute output pin.
44	LVDD	—	L channel power supply pin. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)
45	LCHO	O	L channel output pin.
46	LVSS	—	L channel ground pin, Must be connected to 0V.
47	RVSS	—	R channel ground pin, Must be connected to 0V.
48	RCHO	O	R channel output pin.
49	RVDD	—	R channel power supply pin. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)
50	XVDD	—	Crystal oscillator power supply pin. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)
51	XIN	I	Connections for a 16.9344MHz crystal oscillator pin.
52	XOUT	O	
53	XVSS	—	Crystal oscillator ground pin. Must be connected to 0V.
54	ASLRCK	I	L/R clock input pin. (Must be connected to 0V when unused)
55	ASDACK	I	Bit clock input pin. (Must be connected to 0V when unused)
56	ASDFIN	I	L/R channel data input pin. (Must be connected to 0V when unused)
57	LRSY	O	L/R clock output pin.
58	DATACK	O	Bit clock output pin.
59	DATA	O	L/R channel data output pin.
60	16M	O	16.9344MHz output pin.
61	SFSY	O	Subcode frame synchronization signal output pin. This signal falls when the subcode is in the standby state.
62	SBSY	O	Subcode clock synchronization signal output pin.
63	PW	O	Subcode P, Q, R, S, T, U and W output pin.
64	SBCK	I	Subcode readout clock input pin.
65	CE	I	Chip enable signal input pin.
66	CL	I	Data transfer clock input pin.
67	DI	I	Data input pin.
68	DO	O	Data output pin.
69	*INT	O	Interruption signal output pin.
70	*WRQ	O	Interruption signal output pin.
71	*RES	I	Reset input pin. This pin must be set low briefly after power is first applied.
72	DRF	O	Focus ON detect pin.

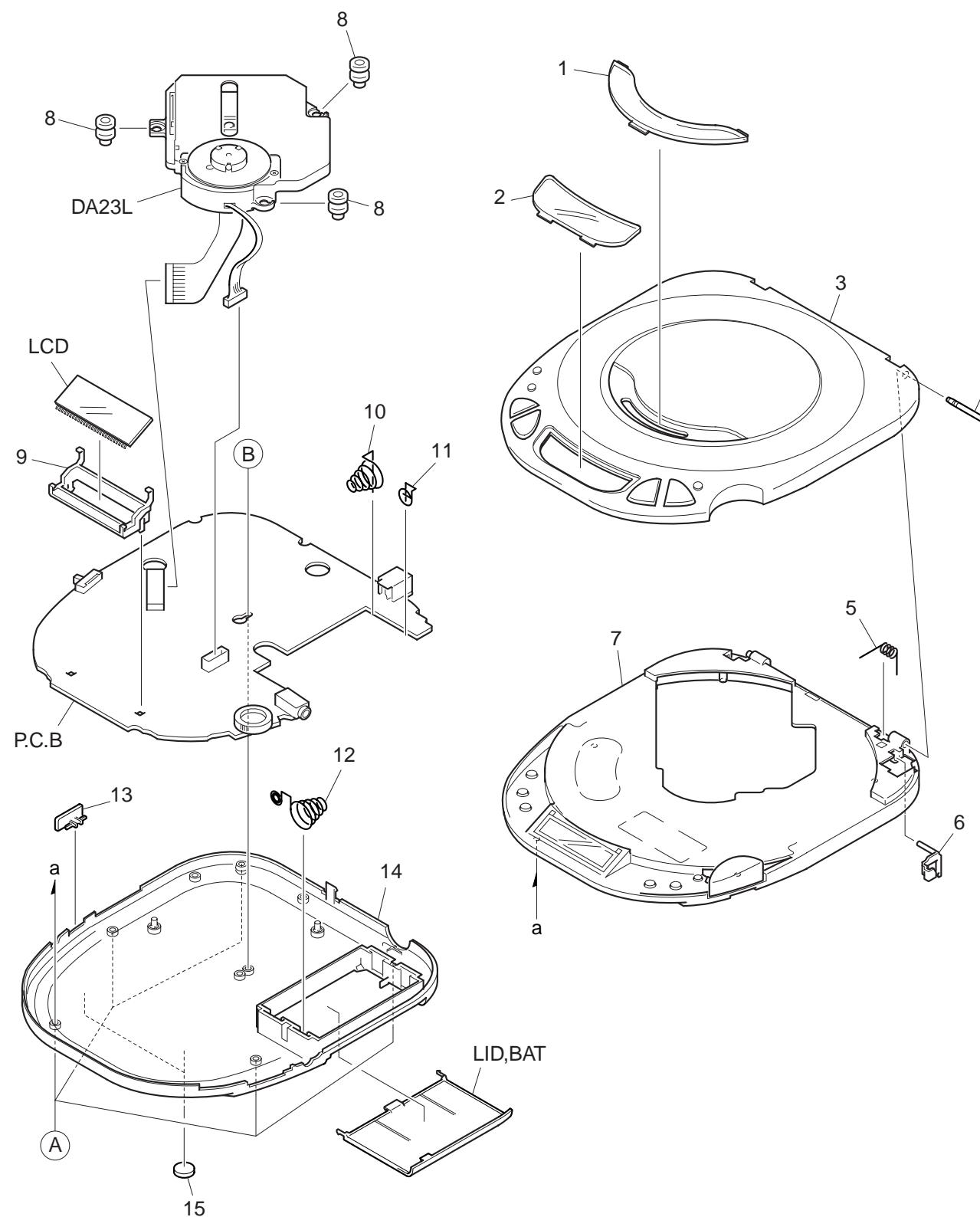
Pin No.	Pin Name	I/O	Description
73	VDD5V	—	Microprocessor interface power supply. (2000pF or more path controller to be inserted at a point nearer to the pin between this pin and GND)
74	VSS	—	Digital ground pin. Must be connected to 0V.
75	CONT6	I/O	General-purpose input/output pin 6.
76	CONT7	I/O	General-purpose input/output pin 7.
77	V/*P	O	Rough servo/phase control automatic switching monitor output pin. “H” for rough servo and “L” for phase servo.
78	FSEQ	O	Synchronization signal detection output pin. Outputs a high level when the synchronization signal detected from the EFM signal and the internally generated synchronization signal agree.
79	DEFECT	I/O	Defect pin. Which becomes an input pin after reset and can be controlled externally. This becomes the defect monitor pin under control by command.
80	EFMO	O	EFM signal output pin.

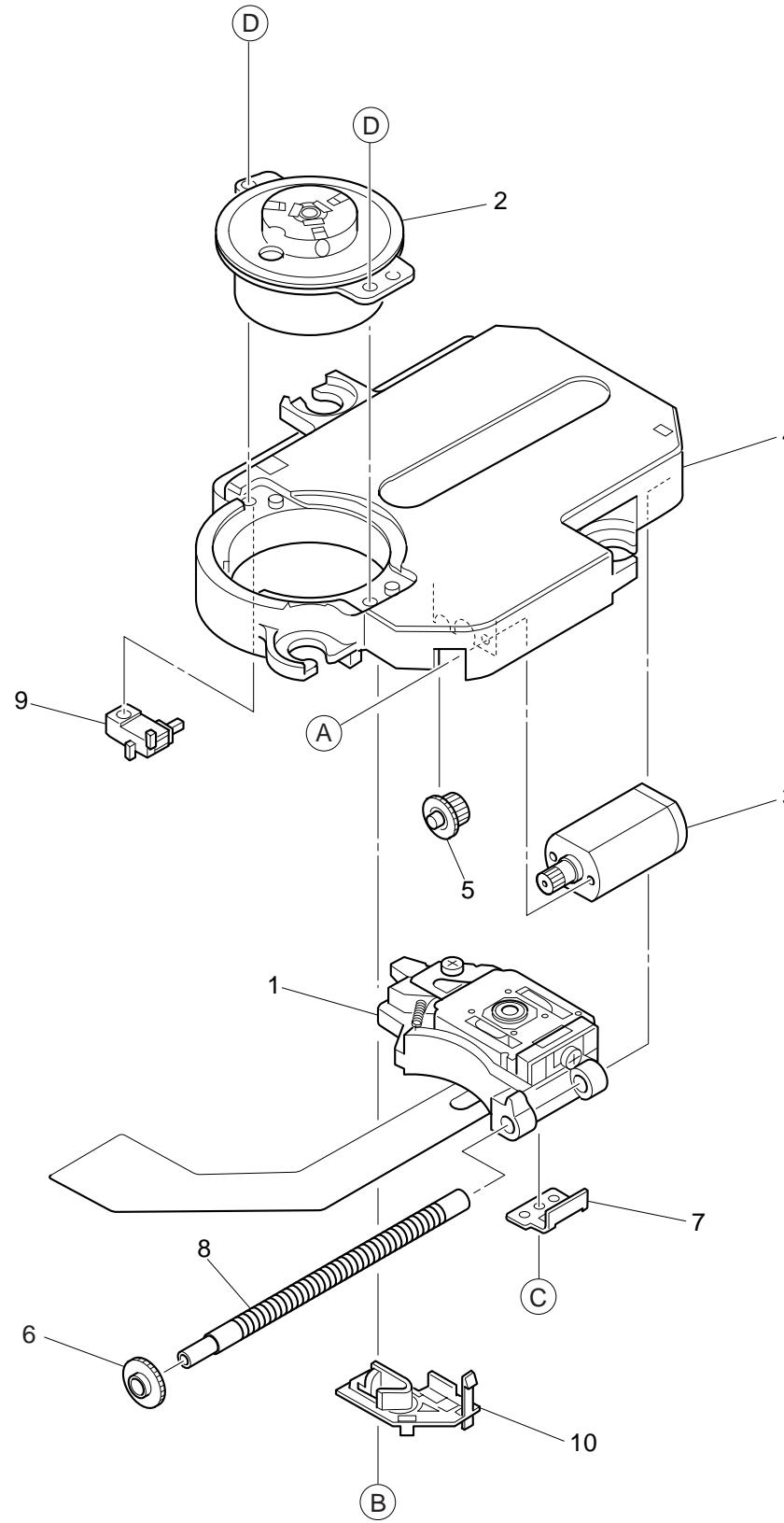
IC, μ PD789405AGC-013

Pin No.	Pin Name	I/O	Description
1	VDO1	—	Positive polarity power supply (except for port section).
2	BIAS	—	Feeding the LCD drive power supply voltage.
3-5	VLC0-VLC2	—	LCD drive power supply voltage.
6	VSS1	—	Ground potential (except for port section).
7-10	COM0-COM3	O	Common signal output from LCD controller/driver.
11-38	S0-S27	O	Segment signal output from LCD controller/driver.
39	AVDD	—	A/D comparator analog power supply.
40	AVREF	—	A/D comparator reference voltage.
41-47	ANI6-0	I	Analog input signal to A/D comparator.
48	AVSS	—	A/D comparator ground potential.
49-52	INTP3-INTP0	I	External interrupt input whose effective edge (rise-up or fall-down or both edges of rise-up and fall-down) can be specified.
53	TO2	O	Output signal from 8-bit timer (TM02).
54	SI	I	Serial data input signal of serial interface.
55	SO	O	Serial data output signal of serial interface
56	SCK	I/O	Serial clock input/output signal of serial interface
57-60	P53-P50	I/O	Port 5. 4-bit N-channel open-drain input/output port. Input or output; can be specified in units of 1 bit. When it is used as an input port, built-in pull-up resistor can be used as specified by mask option.
			Port0. 4-bit input/output port. Input or output; can be specified in units of 1 bit. When it is used as an input port, built-in pull-up resistor can be used as specified by software
			Port 4. 8-bit input/output port. Input or output; can be specified in units of 1 bit. When it is used as an input port, built-in pull-up resistor can be used as specified by software.
			System reset input.
68	X2	—	Terminal to connect external crystal for main system clock oscillation.
69	X1	I	
70	VSS0	—	Ground potential of port section.
71	VDD0	—	Positive polarity power supply for port section.
72	XT2	—	Terminal to connect external crystal for sub system clock oscillation.
73	XT1	I	
74	IC/VPP	—	This pin is internally connected. Connect this pin directly to V_{SS_0} or V_{SS_1} .
75-80	P45-P40	I	Key-return signal detection input signal.

IC, LA9253M

Pin No.	Pin Name	I/O	Description
1	FIN1	I	Pick-up signal input.
2	FIN2	I	
3	TIN1	I	
4	TIN2	I	
5	REF1	I	
6	VREF	O	Reference voltage output.
7	LDS	I	APC monitor voltage input.
8	LDD	O	APC output.
9	GND	—	GND.
10	LDOF	I	laser OFF pin (H: ON L: OFF).
11	ODRV	I	Speed switch pin (H: double L: normal speed).
12	AGON	I	AGC ON pin (H: ON L: OFF).
13	EFBL	I	FE balance adjustment pin.
14	TESO	O	TE signal output for TES.
15	TESI	I	TE input for TES formation.
16	TES	O	TES output.
17	HFL	O	HFL signal output.
18	TE	O	TE signal output.
19	TE-	I	Minus input for TE gain design.
20	FE	O	FE signal output.
21	FE-	I	Minus input for FE gain design.
22	RFEV	O	RF envelop signal output.
23	N/C	—	Pin N/C.
24	BH	I	Capasitance connection pin for RF bottom clamp.
25	PH	I	Capasitance connection pin for RF gain design.
26	N/C	—	Pin N/C.
27	RF	O	RF signal output.
28	RF-	I	Minus input for RF signal gain design.
29	RFSW	I	Switch for equalizer design when RF has double speed.
30	VCC	—	Power supply.





CD MECHANISM PARTS LIST

DESCRIPTIONで判断できない物は "REFERENCE NAME LIST" を参照してください。
If can't understand for Description please kindly refer to "REFERENCE NAME LIST".

REF. NO.	PART NO.	KANRI NO.	DESCRIPTION
1	S0-A41-A20-600		PICKUP LASER ASSY
2	SM-10A-108-001		MOTOR ASSY SPINDLE
3	S0-M10-A10-900		MOTOR SLED ASSY
4	S2-311-A12-200		CHASSIS
5	S2-511-A23-200		GEAR MIDDLE
6	S2-511-A23-100		GEAR,SCREW
7	S2-511-A23-400		GEAR,RACK
8	S2-511-A07-900		SPINDLE SCREW
9	S4-S13-A00-200		SW,LEAF
10	S2-451-A18-100		HOLDER GEAR
A	SS-EXE-A04-000		SCR PAN PCS 1.4-2.2
B	SS-GXE-A00-300		SPECIAL SCREW
C	SS-EXE-A14-100		SPECIAL SCREW
D	SS-GXE-A00-202		SPECIAL SCREW M1.7-4.0

ACCESSORIES/PACKAGE LIST

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If can't understand for Description please kindly refer to "REFERENCE NAME LIST".

REF. NO	PART NO.	KANRI NO.	DESCRIPTION
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▲ 1	87-B30-285-010		AC ADAPTOR, AC-D603HRNC
2	87-B30-326-010		HEADPHONE, HP-M048
3	8A-HC7-914-010		IB, LH(3L)C F
4	87-A90-312-010		PLUG, CONVERSION WTN-1157R1

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